

ON Semiconductor®

FDS6690AS

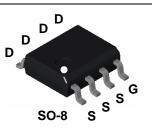
30V N-Channel PowerTrench[®] SyncFET[™]

General Description

The FDS6690AS is designed to replace a single SO-8 MOSFET and Schottky diode in synchronous DC:DC power supplies. This 30V MOSFET is designed to maximize power conversion efficiency, providing a low $R_{DS(ON)}$ and low gate charge. The FDS6690AS includes an integrated Schottky diode using ON Semiconductor's monolithic SyncFET technology. The performance of the FDS6690AS as the low-side switch in a synchronous rectifier is close to the performance of the FDS6690A in parallel with a Schottky diode.

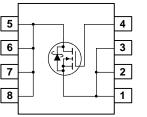
Applications

- DC/DC converter
- Low side notebooks



Features

- 10 A, 30 V. $R_{DS(ON)}$ max= 12 m Ω @ V_{GS} = 10 V $R_{DS(ON)}$ max= 15 m Ω @ V_{GS} = 4.5 V
- Includes SyncFET Schottky diode
- Low gate charge (16nC typical)
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain-Source	Voltage		30	V
V _{GSS}	Gate-Source	Voltage		±20	V
I _D	Drain Curren	t – Continuous	(Note 1a)	10	A
		– Pulsed		50	
P _D	Power Dissip	ation for Single Operation	(Note 1a)	2.5	W
			(Note 1b)	1.2	
			(Note 1c)	1	
T_J, T_{STG}	Operating an	d Storage Junction Tempera	-55 to +150	°C	
Therma	I Characte	eristics			
$R_{\theta JA}$	Thermal Res	istance, Junction-to-Ambient	t (Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)			25 °(
Packag	e Marking	and Ordering Inf	ormation		
Device Marking		Device	Reel Size	Tape width	Quantity
FDS6690AS		FDS6690AS	13"	12mm	2500 units

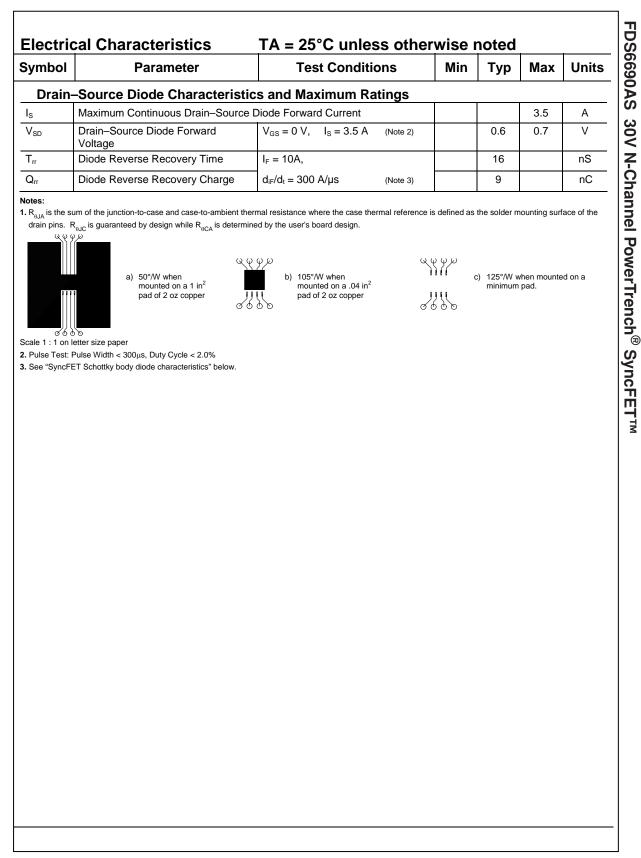
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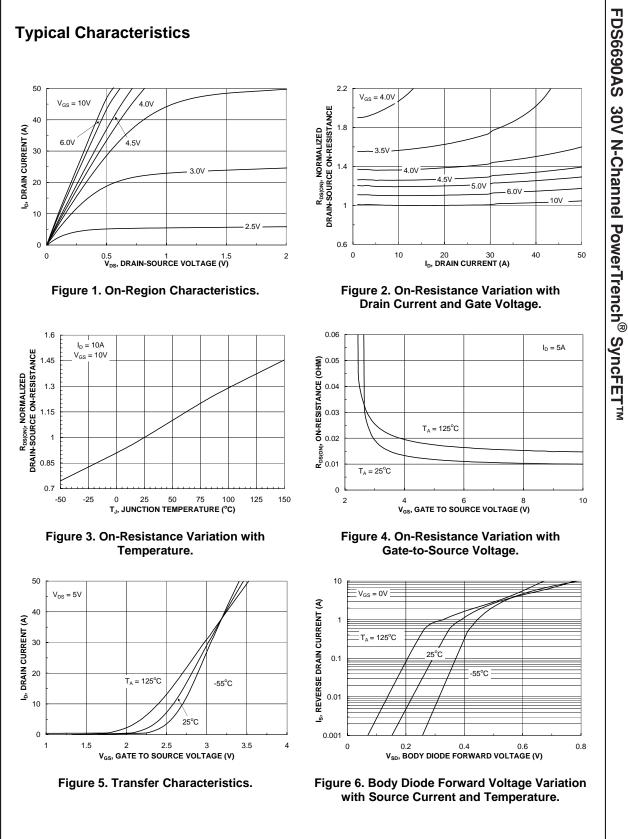
Publication Order Number: FDS6690AS/D

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		1			•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 1 mA$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to 25°C		30		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			500	μΑ
GSS	Gate-Body Leakage	$V_{\text{GS}} = \pm 20 \text{ V}, \qquad V_{\text{DS}} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1	1.6	3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			10 12 15	12 15 19	mΩ
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g fs	Forward Transconductance	$V_{DS} = 15 \text{ V}, \qquad I_{D} = 10 \text{ A}$		45		S
Dvnamic	Characteristics				-	
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		910		pF
Coss	Output Capacitance	f = 1.0 MHz		270		pF
Crss	Reverse Transfer Capacitance			100		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		2.0		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			8	16	ns
t _r	Turn–On Rise Time	$V_{DS} = 15 V$, $I_{D} = 1 A$,		5	10	ns
t _{d(off)}	Turn–Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		25	40	ns
t _f	Turn-Off Fall Time			6	12	ns
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Turn–On Rise Time	$V_{DS} = 15 V,$ $I_D = 1 A,$		11	20	ns
t _{d(off)}	Turn–Off Delay Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		15	27	ns
t _f	Turn–Off Fall Time			8	16	ns
Q _{g(TOT)}	Total Gate Charge at Vgs=10V			16	23	nC
Qg	Total Gate Charge at Vgs=5V	$V_{DD} = 15 \text{ V}, I_{D} = 10 \text{ A}$		9	13	nC
Q _{gs}	Gate–Source Charge	-		2.3		nC
Q _{gd}	Gate–Drain Charge			3.0		nC

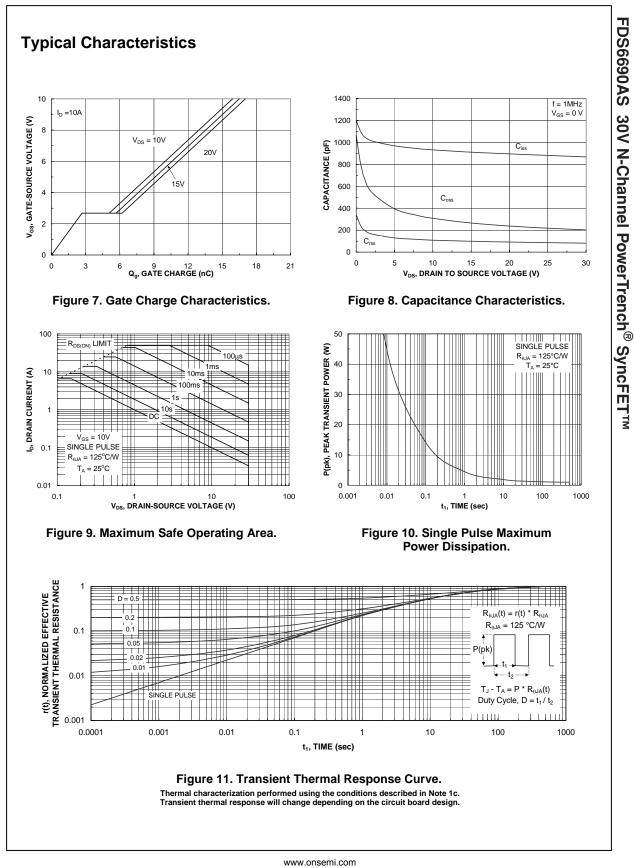
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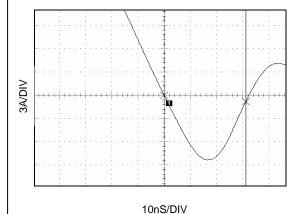


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Typical Characteristics (continued)

SyncFET Schottky Body Diode Characteristics

ON Semiconductor's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 12 shows the reverse recovery characteristic of the FDS6690AS.



at high temperature and high reverse voltage. This will increase the power in the device.

Schottky barrier diodes exhibit significant leakage

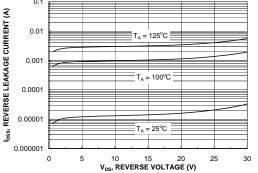
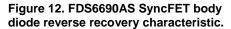
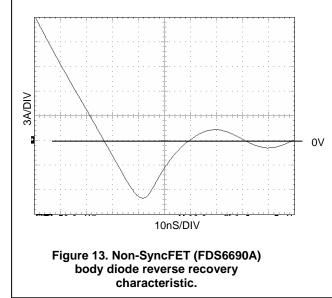


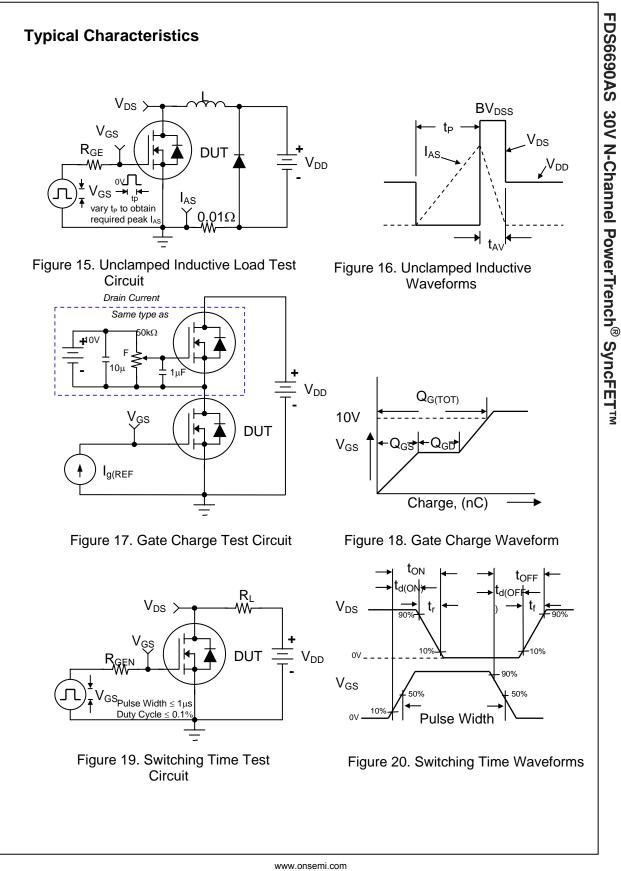
Figure 14. SyncFET body diode reverse leakage versus drain-source voltage and temperature.



For comparison purposes, Figure 13 shows the reverse recovery characteristics of the body diode of an equivalent size MOSFET produced without SyncFET (FDS6690A).



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